Document Number: 79076 Rev. 3.0, 3/2007

Electronic Ignition Control Circuit

The 79076, in conjunction with an appropriate Freescale Power Darlington Transistor, provides an economical solution for automotive ignition applications. The 79076 offers optimum performance by providing closed loop operation of the Power Darlington in controlling the ignition coil current.

Features

- · Hall or Variable Reluctance Sensor Input
- Ignition Coil Voltage Internally Limited to 375 V
- Coil Current Limiting to 7.5 A
- Output On-Time (Dwell) Control
- Dwell Feedback Control to Sense Coil Variation
- Pb-Free Packaging Designated by Suffix Code EG

79076

ELECTRONIC IGNITION CONTROL CIRCUIT



EG (PB-FREE) SUFFIX 98ASB42567B 16-PIN SOIC

ORDERING INFORMATION				
Device Temperature Range (T _A)		Package		
MC79076DW/R2	-30°C to 125°C	16 SOIC		
MCZ79076EG/R2	-30 0 10 123 0	10 3010		

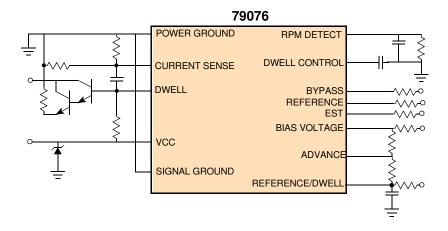


Figure 1. 79076 Simplified Application Diagram





INTERNAL BLOCK DIAGRAM

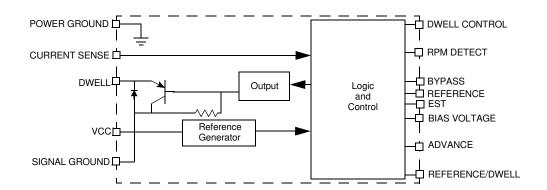


Figure 2. 79076 Simplified Internal Block Diagram



PIN CONNECTIONS

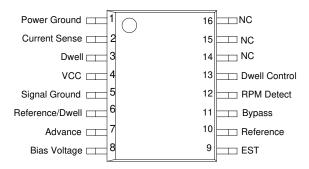


Figure 3. 79076 Pin Connections



ELECTRICAL CHARACTERISTICS

MAXIMUM RATINGS

Table 1. Maximum Ratings

All voltages are with respect to ground unless otherwise noted. Exceeding these ratings may cause a malfunction or permanent damage to the device.

Ratings	Symbol	Value	Unit
ELECTRICAL RATINGS	<u> </u>		
Supply Voltage			V
Steady-State	V _{CC(SUS)}	36	
Transient Conditions (1)	V _{CC(PK)}	50	
Supply Current	I _T		
Transient Conditions (2)		1.0	Α
Transient Negative Current (t _T = 60ms)		-100	mA
Transient Negative Current ($t_T = 1 ms$)		-1.3	Α
Input Voltage (3)			V
Ref/Dwell, Advance	V _{IN1}	-5.0 to 30	
EST, Bypass	V _{IN2}	-5.0 to 24	
Ref/Dwell Input Current	I _{IN1}	-20	mA
Dwell ON Sink Current	I _D		А
Output ON (Operating)		0.3	
Output ON (t = 10ms)		0.8	
Dwell OFF Voltage (4)	V _{D(OFF)}	5.0	V
THERMAL RATINGS			
Storage Temperature	T _{STG}	-65 to 150	°C
Operating Ambient Temperature	T _A	-30 to 125	°C
THERMAL RESISTANCE			
Operating Junction Temperature	TJ	-30 to 150	°C
Thermal Resistance (Junction-to-Ambient) - SO8	Ø _{J-A}	80	°C/W
Peak Package Reflow Temperature During Reflow (5), (6)	T _{PPRT}	Note 6	°C

- 1. Survivability of device with transient voltage applied to V_{CC} pin for a duration not to exceed 10ms.
- 2. Survivability of device with overvoltage applied to V_{CC} pin producing the current for a duration not to exceed 10ms.
- 3. Exceeding this voltage range on the function pin may cause permanent damage to the device.
- 4. A zener diode is incorporated across collector to emitter of the output NPN device to prevent voltage overdrive of the external Darlington switch transistor.
- 5. Pin soldering temperature limit is for 10 seconds maximum duration. Not designed for immersion soldering. Exceeding these limits may cause malfunction or permanent damage to the device.
- Freescale's Package Reflow capability meets Pb-free requirements for JEDEC standard J-STD-020C. For Peak Package Reflow
 Temperature and Moisture Sensitivity Levels (MSL),
 Go to www.freescale.com, search by part number [e.g. remove prefixes/suffixes and enter the core ID to view all orderable parts. (i.e.
 MC33xxxD enter 33xxx), and review parametrics.



STATIC ELECTRICAL CHARACTERISTICS

Table 2. Static Electrical Characteristics

Characteristics noted under conditions 7.0 V \leq V_{CC} \leq 18 V, -40°C \leq T_A \leq 125°C, GND = 0 V unless otherwise noted. Typical values noted reflect the approximate parameter means at T_A = 25°C under nominal conditions unless otherwise noted.

Characteristic	Symbol	Min	Тур	Max	Unit
INPUTS				<u> </u>	
Advance Input Resistance (V _{CC} = 16 V, Ref/Dwell = 1.0 V, Advance = 1.0 mA, EST = Bypass = 0 V)	R _(A)	15	18	25	kΩ
Advance Voltage ⁽⁷⁾ $V_{CC} = 16 \text{ V, Ref/Dwell} = 1.0 \text{ V, EST} = \text{Bypass} = 0 \text{ V}$	$V_{TH(A)}$	-	0.05	0.1	V
Advance Threshold Voltage $^{(7)}$ (V _{CC} = 16 V, Ref/Dwell = 1.0 V, EST = Bypass = 0 V,) Dwell = Reference = RPM Detect = open, Dwell Control = sinking 10 μ A)					V
Increasing Decreasing Hysteresis	$V_{TH+(A)} \\ V_{TH-(A)} \\ V_{HYS(A)}$	$V_B + 0.103$ $V_B + 0.045$ 0.018	$V_B + 0.114$ $V_B + 0.068$ 0.045	V _B + 0.130	
Bypass Input Resistance $(V_{CC} = 16 \text{ V}, \text{ Ref/Dwell} = \text{Advance} = 3.0 \text{ V}, \text{ EST} = \text{Bypass} = 0 \text{ V})$	$R_{(BP)}$	6.0	9.2	16	kΩ
Bypass Voltage (V _{CC} = 16 V, Ref/Dwell = Advance = 1.0 V, EST = 0V)	$V_{(BP)}$	-	0.065	0.1	V
Bypass Threshold Voltage ⁽⁸⁾ (Ref/Dwell = Advance = 1.0 V, EST = 3.0 V) Increasing Decreasing Hysteresis	V _{TH+(BP)} V _{TH-(BP)} V _{HYS(BP)}	V _B + 1.6 V _B + 0.9 0.65	V _B + 0.188 V _B + 0.103 0.86	V _B + 2.1	V
Current Sense Threshold Voltage ⁽⁹⁾ (V _{CC} = 16 V, Ref/Dwell = Advance = 1.0 V, EST = Bypass = 3.0 V)	V _{TH(CS)}	90	105	121	mV
EST Input Resistance (V _{CC} = 16 V, Ref/Dwell = Advance = 1.0 V, Bypass = 3.0 V)	R _(EST)	7.0	10.3	18	kΩ
EST Input Voltage (EST Mode) (V _{CC} = 16 V, Ref/Dwell = Advance = 1.0 V, Bypass = 3.0 V)	V _(EST)	-	0.07	0.1	V

- Advance Threshold Voltage is the positive (or negative) going voltage on Advance necessary cause the Dwell Control voltage to positive (or negative) going transition 2.0 V respectively. It is expressed as V_{TH±(A)} = V_B + V_X where V_B is the Bias Voltage and V_X is the additional voltage necessary to attain the threshold.
- 8. Bypass Threshold Voltage is the positive (or negative) going voltage on Bypass necessary cause the Dwell voltage to positive (or negative) going transition 1.5 V respectively. It is expressed as V_{TH±(BP)} = V_B + V_X where V_B is the Bias Voltage and V_X is the additional voltage necessary to attain the threshold.
- 9. Increasing voltage on Current Sense which when attained will cause Dwell to transition low to 1.5 V with a 10 mA load.



Characteristics noted under conditions 7.0 V \leq V_{CC} \leq 18 V, -40°C \leq T_A \leq 125°C, GND = 0 V unless otherwise noted. Typical values noted reflect the approximate parameter means at T_A = 25°C under nominal conditions unless otherwise noted.

Characteristic	Symbol	Min	Тур	Max	Unit
EST Threshold Voltage (10)					V
(Ref/Dwell = Advance = 1.0 V, Bypass = 3.0 V)					
Increasing	V _{TH+(EST)}	1.65	1.86	2.0	
Decreasing	V _{TH-(EST)}	0.8	0.89	-	
Hysteresis	V _{HYS(EST)}	0.79	0.97	-	
Ref/Dwell Current (11)	I _(R/D)				μΑ
(V _{CC} = 16 V, Advance = 1.0 V, EST = Bypass = 0 V)	(1.7.2)				
Ref/Dwell Voltage = 1.0 V		-12	-1.38	1.0	
Ref/Dwell Voltage = 20 V		-1.0	0.02	5.0	
Ref/Dwell Clamp Voltage	V _{(R/D)CL}				V
(V _{CC} = 16 V, Advance = 1.0 V, EST = Bypass = 0 V)	(, , , -				
I _{R/D} = 100μA (Sourcing)		-0.01	-0.04	0.2	
I _{R/D} = 1.0mA (Sourcing)		-0.62	-0.54	-	
Ref/Dwell Threshold (Bypass Mode) (12)					V
(Advance = 1.0 V, EST = Bypass = 0 V, Reference = sinking 10 μA)					
Increasing	V _{TH+(R/D)BP}	V _B + 0.09	V _B + 0.106	V _B + 0.116	
Decreasing	V _{TH-(R/D)BP}	V _B + 0.018	$V_{B} + 0.03$	-	
Hysteresis	V _{HYS(R/D)BP}	0.055	0.076	-	
Ref/Dwell Threshold (EST Mode) (12)					V
(Advance = 1.0 V, EST = 0 V, Bypass = 3.0 V, Reference = sinking					
10 μΑ)	V _{TH+(R/D)EST}	V _B + 0.445	$V_B + 0.50$	V _B + 0.535	
Increasing	V _{TH-(R/D)EST}	V _B + 0.038	V _B + 0.062	-	
Decreasing	V _{HYS(R/D)EST}	0.395	0.436	-	
Hysteresis	((. ,, 5) _ 5.				
Ref/Dwell Threshold (No Pump) (13)					V
(Advance = 1.0 V, EST = Bypass = 0 V, Dwell = sinking 10 mA)					
Increasing	$V_{TH+(R/D)NP}$		$V_B + 0.118$	$V_B + 0.128$	
Decreasing	V _{TH-(R/D)NP}	$V_B + 0.021$	$V_B + 0.047$	-	
Hysteresis	V _{HYS(R/D)NP}	$V_B + 0.013$	$V_B + 0.072$	-	

- EST Threshold Voltage is the positive (or negative) going voltage on EST necessary cause the Dwell voltage to positive (or negative) going transition 1.5 V respectively. It is expressed as V_{TH±(EST)} and is in reference to ground.
- 11. Ref/Dwell can either source or sink current; A minus sign denotes the Ref/Dwell is sourcing current.
- 12. Ref/Dwell Threshold Voltage (Bypass Mode) is the positive (or negative) going voltage on Ref/Dwell necessary cause the Reference voltage to positive (or negative) going transition 1.5 V respectively. It is expressed as V_{TH±(RD)} = V_B + V_X where V_B is the Bias Voltage and V_X is the additional voltage necessary to attain the threshold.
- 13. Ref/Dwell Threshold Voltage (No Pump) is the positive (or negative) going voltage on Ref/Dwell necessary cause the Dwell voltage to positive (or negative) going transition 1.5 V respectively. It is expressed as V_{TH±(RD)} = V_B + V_X where V_B is the Bias Voltage and V_X is the additional voltage necessary to attain the threshold. Advance = 1.0 V providing no input assist or "No Pump" influence of Dwell signal; Reference open.



Characteristics noted under conditions 7.0 V \leq V_{CC} \leq 18 V, -40°C \leq T_A \leq 125°C, GND = 0 V unless otherwise noted. Typical values noted reflect the approximate parameter means at T_A = 25°C under nominal conditions unless otherwise noted.

Characteristic	Symbol	Min	Тур	Max	Unit
Ref/Dwell Threshold (Max Pump) (14)					V
(V _{CC} = 16 V, Advance = 3.0 V, EST = Bypass = 0 V, Dwell sinking 10 mA, Dwell Control = open)					
Increasing Decreasing	` '	V _B + 0.175			
Hysteresis	` '	$V_B + 0.115$ $V_B + 0.025$		V _B + 0.735	

OUTPUTS

Bias Resistance to Ground	R _(B)				kΩ
$\begin{aligned} & \text{Dwell} = \text{V}_{\text{CC}} = \text{Ref/Dwell} = \text{Reference} = \text{Dwell Control} = \text{open}, \\ & \text{Advance} = 1.0 \text{ V}, \text{EST} = \text{Bypass} = 0 \text{ V} \end{aligned}$	(5)	0.55	0.68	0.9	
Bias Voltage (Bypass Mode)	V _{(B)BP}				V
Ref/Dwell = Advance = 1.0 V, EST = Bypass = 0 V		2.25	2.43	2.6	
Bias Voltage Regulation (Bypass Mode)	V _{(B)BP}				mV
Ref/Dwell = Advance = 1.0 V, EST = Bypass = 0 V		-	30	40	
Bias Voltage (EST Mode)	V _{(B)EST}				V
V_{CC} = 16 V, Ref/Dwell = Advance = 1.0 V, EST = 0 V, Bypass = 3.0 V		1.9	2.04	2.2	
Dwell Saturation Voltage	V _{(D)SAT}				V
V_{CC} = 4.0 V, I_D = 40 mA, Ref/Dwell = Advance =3.0 V, EST = Bypass = 0 V		-	0.05	0.1	
V_{CC} = 16 V, I_D = 160 mA, Ref/Dwell = Advance =3.0 V, EST = Bypass = 0 V		-	0.14	0.24	
V_{CC} = 24 V, I_D = 240 mA, Ref/Dwell = Advance =1.0 V, EST = Bypass = 3.0 V		-	0.20	0.35	
V_{CC} = 36 V, I_D = 360 mA, Ref/Dwell = Advance =1.0 V, EST = Bypass = 3.0 V		-	0.29	0.5	
Dwell Reverse Clamp Voltage (15)	V _{(D)REV}	-0.9	-0.98	-1.2	V
Dwell Leakage Current ⁽¹⁶⁾	I _{(D)KG}				μΑ
V_{CC} = 16 V, Dwell = 5.0 V, Ref/Dwell = Advance = 3.0 V, EST = Bypass = 0, Bias Voltage = Reference = open	, , -	-	0.044	50	
Reference Low (17)	V _{(R)LOW}				٧
I_R = sinking 0.3 mA, Ref/Dwell = Advance = 1.0 V, EST = Bypass = 0 V		-	0.13	0.22	

- 14. Ref/Dwell Threshold Voltage (Max Pump) is the positive (or negative) going voltage on Ref/Dwell necessary cause the Dwell voltage to positive (or negative) going transition 1.5 V respectively. It is expressed as $V_{TH\pm(RD)} = V_B + V_X$ where V_B is the Bias Voltage and V_X is the additional voltage necessary to attain the threshold. Advance = 3.0 V providing maximum input assist or Max Pump" influence of Dwell signal; Reference = Dwell Control = open.
- 15. All pins open except Pwr Gnd with Dwell sinking 200 mA.
- 16. Limit conditions with Dwell output NPN in the OFF condition.
- 17. Reference saturation voltage to ground with 0.3mA of current going into the Reference.



Characteristics noted under conditions 7.0 V \leq V_{CC} \leq 18 V, -40°C \leq T_A \leq 125°C, GND = 0 V unless otherwise noted. Typical values noted reflect the approximate parameter means at T_A = 25°C under nominal conditions unless otherwise noted.

Characteristic	Symbol	Min	Тур	Max	Unit
Reference High/Un-Clamped (27)	V _{(R)HI/UNCL}				V
V_{CC} = 4.0 V, I_{R} = sourcing 100 mA, Ref/Dwell = 3.0 V, Advance = 1.0 V, EST = Bypass = 0 V	,	3.2	3.36	-	
Reference High/Clamped (27)	V _{(R)HI/CL}				V
$V_{CC} = 16 \text{ V}$, Ref/Dwell = 3.0 V, Advance = 1.0 V, EST = Bypass = 0 V	, ,				
I _R = sourcing 10 μA		-	5.41	6.0	
I _R = sourcing 1.0 mA		12	15.3	-	

CONTROLS

Dwell Control Negative Clamp Voltage (27)	V _{(DC)-CL}				V
V_{CC} = 16 V, I_{DC} = sourcing 100 $\mu A,$ Ref/Dwell = Advance = 1.0 V, EST = Bypass = 0 V		0.5	0.7	0.8	
Dwell Control Positive Clamp Voltage (27)	V _{(DC)+CL}				V
V_{CC} = 16 V, I_{DC} = sinking 100 $\mu A,Ref/Dwell$ = 1.0 V, Advance = Open, EST = Bypass = 0 V	, ,	8.0	8.2	8.4	
Dwell Control Charge Current (27)	I _{(DC)CHG}				μΑ
V_{CC} = 16 V, Ref/Dwell = 1.0 V, Advance = Dwell Control = 3.0 V, EST = Bypass = 0 V	, ,	30	47	58	
Dwell Control Discharge Current (27)	I _{(DC)DISCHG}				μΑ
V_{CC} = 16 V, Current Sense = 0.5 V, Ref/Dwell = Advance = 1.0 V, EST = Bypass = 0 V	, ,	18	33	48	
Dwell Control Input Current (27)	I _{(DC)SINK}				μΑ
V_{CC} = 16 V, Ref/Dwell = Advance = 1.0 V, EST = Bypass = 0 V, Dwell Control = 7.0 V		-	1.1	2.5	
RPM Detect Charge Current ON (27)	I _{(RPM)CHG}				mA
$V_{CC} = 16 \text{ V}$, Ref/Dwell = 3.0 V, Advance = 1.0 V, EST = Bypass = 0 V		-4.0	0.54	1.0	
RPM Detect Current (27)	I _{(RPM)LKG}				μΑ
V_{CC} = 16 V, 1.0 V = Ref/Dwell = Advance = 3.0 V, EST = Bypass = 0 V					
RPM Detect = 0.5 V		04.0	0.55	1.0	
RPM Detect = 1.5 V		-0.1	0.01	0.1	
RPM Detect Clamp Voltage (27)	V _{(RPM)CL}				V
V_{CC} = 16 V, Ref/Dwell = 3.0 V, Advance = 1.0 V, EST = Bypass = 0 V, RPM Detect = sourcing 16 μA		2.4	2.5	2.7	

- 18. Dwell Control adjusts the reference voltage of Dwell Comparator.
- 19. Dwell Control. sourcing 100 μA .
- 20. Dwell Control sinking 100 μA.
- 21. Dwell Control at 3.0 V; Internal Dwell Control transistor OFF.
- 22. Dwell Control at 3.0 V; Internal Dwell Control transistor ON.
- 23. Dwell Control at 7.0 V; Internal Dwell Control transistor OFF.
- 24. Q53 and Q54 both ON; Measured with RPM Detect voltage at 0.5 V to reflect maximum source current capability. See Typical Applications on page 10
- 25. Q53 and Q54 both OFF; Measured with RPM Detect voltage at 0.5 V and 1.5 V to reflect maximum leakage current. Typical Applications on page 10
- 26. Q53 and Q54 both ON; RPM Detect sinking 16 μ A. Typical Applications on page 10



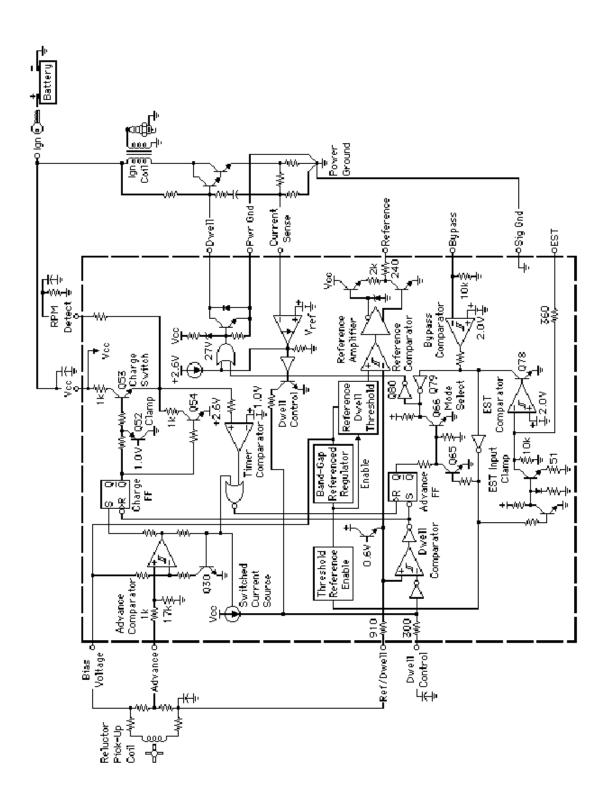
Characteristics noted under conditions 7.0 V \leq V_{CC} \leq 18 V, -40°C \leq T_A \leq 125°C, GND = 0 V unless otherwise noted. Typical values noted reflect the approximate parameter means at T_A = 25°C under nominal conditions unless otherwise noted.

Characteristic	Symbol	Min	Тур	Max	Unit
RPM Detect Threshold (27)	V _{TH-(RPM)}				V
V _{CC} = 16 V, Ref/Dwell = Advance = 3.0 V, EST = Bypass = 0 V		8.0	0.92	1.0	
RPM Detect Charge Current	I _{(RPM)CHG}				mA
V _{CC} = 16 V, Ref/Dwell = 3.0 V, Advance = 1.0 V, EST = Bypass = 0 V		-	-2.0	-	

^{27.} Decreasing Threshold; RPM Detect voltage decreased from 0.6 V until Dwell voltage transitions low to 1.5 V with 10 mA load.



TYPICAL APPLICATIONS

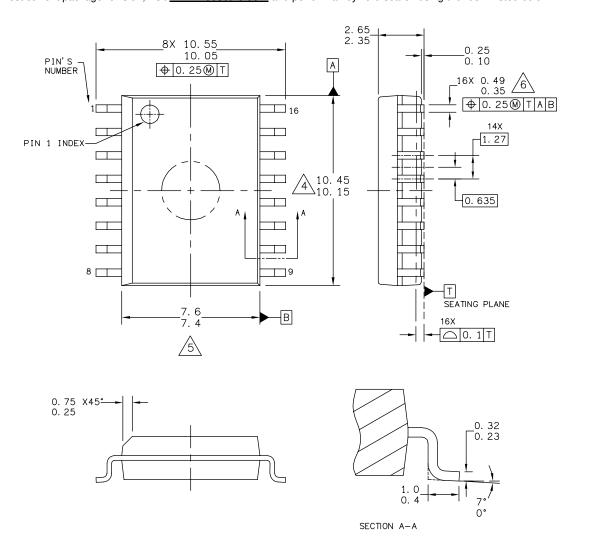




PACKAGING

PACKAGE DIMENSIONS

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16LD SOIC W/B, 1.27 PITCH CASE-OUTLINE		CASE NUMBER	R: 751G-04	02 JUN 2005
		STANDARD: JE	IDEC MS-013AA	

DW SUFFIX EG SUFFIX (PB-FREE)

16-PIN PLASTIC PACKAGE 98ASB42567B ISSUE F



REVISION HISTORY

REVISION	DATE	DESCRIPTION OF CHANGES
3.0	3/2007	 Implemented Revision History page Converted to Freescale format Added MCZ79076EG/R2 to the Ordering Information Removed MCCF79076 and all corresponding references.



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